

LT261A

■ Features

- Operation by small magnet due to high sensitivity
Operating point<10mT
- Combining a GaAs Hall device and an IC in a compact package (2.9X1.5X1.1mm)
- Wide operation temperature range obtained by GaAs Hall device (-20 to +125°C)
- Long life time due to noncontact-type

■ Applications

- FDD
- HDD
- Water meter
- Car stereo
- Microswitch, etc.

■ Absolute Maximum Ratings (Ta=25°C)

Parameter	Symbol	Rating	Unit
Supply voltage	V _{CC}	18	V
Output voltage	V _{OUT}	18	V
Output current	I _O	5	mA
Power dissipation	P _D	100	mW
Operating temperature	T _{OPR}	-20 to +125	°C
Storage temperature	T _{STG}	-55 to +150	°C
Soldering temperature ^{*1}	T _{SOL}	260	°C

*1 Soldering time : within 10 seconds

■ Electrical Characteristics (Ta=25°C)

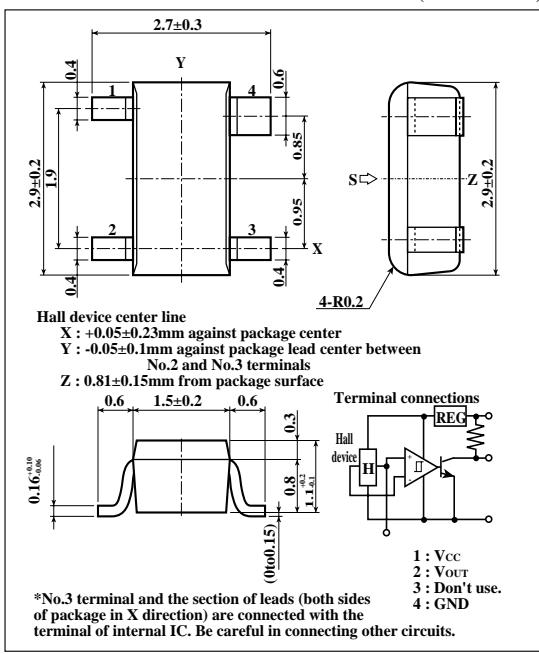
Parameter	Symbol	Conditions	MIN.	TYP.	MAX.	Unit
Operating magnetic flux density	B _{OP}	V _{CC} =16V V _{OO} =16V	-	-	10	mT
	B _{RP}		-10	-	-	mT
Hysteresis breadth	B _H		-	-	5	mT
Operating voltage	V _{CC}		4.5	-	16	V
Supply current	I _{CC}	V _{CC} =16V, B<-10mT	-	-	10.5	mA
Low level output voltage	V _{OL}	V _{CC} =16V, I _O =4mA, B>=10mT	-	-	0.4	V
High level output voltage	V _{OH}	V _{CC} =16V, I _O =-100μA, B<-10mT	13.9	-	-	V
Output short circuit current	I _{OS}	V _{CC} =16V	-1.55	-	-0.80	mA
Operating point temperature drift	ΔB _{OP}	V _{CC} =16V, T _a =-20°C to +80°C	-6	-	6	mT

GaAs Hall IC for Noncontact Switch
(Alternating magnetic field-type*)

*Zero-cross is not warranted.

■ Outline Dimensions

(Unit : Fmm)



As for dimensions of tape-packaged products, refer to page 44 .

■ Operating Explanation

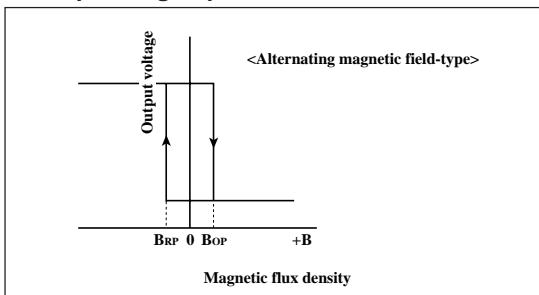


Fig. 1 Operating Magnetic Flux Density vs. Supply Voltage

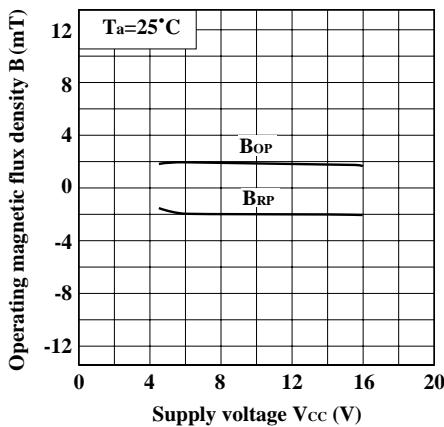


Fig. 3 Supply Current vs. Supply Voltage

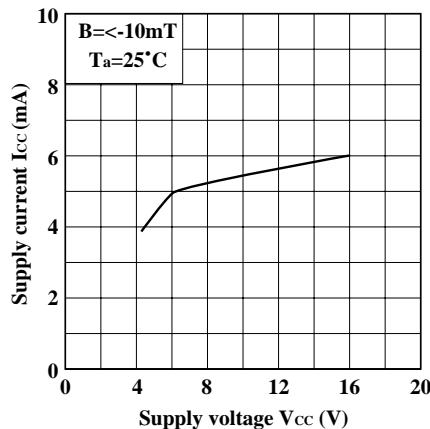


Fig. 5 Low Level Output Voltage vs. Output Current

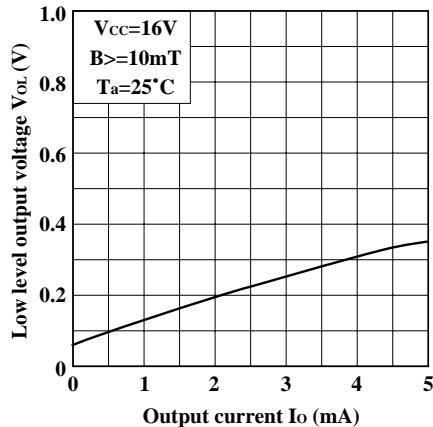


Fig. 2 Operating Magnetic Flux Density vs. Ambient Temperature

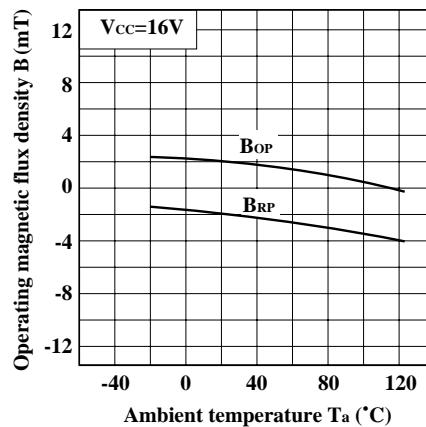


Fig. 4 Supply Current vs. Ambient Temperature

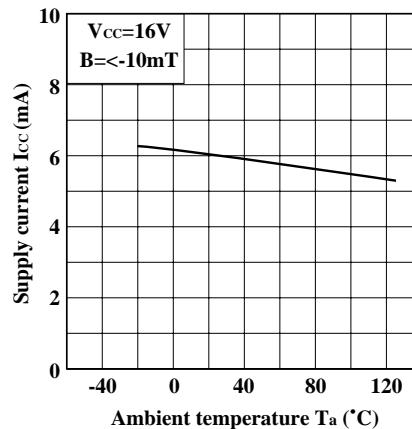


Fig. 6 Low Level Output Voltage vs. Ambient Temperature

